



Response
200315950-1

IN THE UNITED STATES
PATENT AND TRADEMARK OFFICE

In re Patent Application of:

Inventor:	Chen, et al	Confirmation No:	8634
Serial No.	10/816,509	Examiner:	James D Sells
Filed:	Mar 31, 2004	Group Art Unit:	1734
Title:	System And Method For Direct-Bonding Of Substrates		

Commissioner for Patents
P O BOX 1450
Alexandria VA 22313-1450

RESPONSE TO RESTRICTION REQUIREMENT

In response to your Office Action/Restriction Requirement dated February 24, 2005; Applicants affirm the election of Group I (Claims 1-12) without traverse.

Hewlett-Packard Company
1000 NE Circle Blvd. m/s 422B
Corvallis, OR 97330
(541) 715-4197

Respectfully submitted,

Chen, et al

By:
Timothy F. Myers, Reg No: 42,919
Attorney For Applicants

I hereby certify that this correspondence is being deposited on the date indicated below with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, PO Box 1450, Alexandria, VA 22313.

Signature
Timothy F. Myers
Typed Name
Date of Signature 3/3/05